



2812

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor's Application of)
Shunpei YAMAZAKI et al.)
Serial No. 09/362,192)
Filed: July 28, 1999) Group Art Unit: 2812
For: SEMICONDUCTOR DEVICE) Examiner: V. Simkovic
HAVING SEMICONDUCTOR)
CIRCUIT COMPRISING)
SEMICONDUCTOR ELEMENT)
AND METHOD FOR)
MANUFACTURING THE SAME)

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Election
J McMillan
4/20/01

AMENDMENT AND RESPONSE TO ELECTION REQUIREMENT

Honorable Commissioner for Patents

Washington, D.C. 20231

Sir:

In response to the Office Action of March 16, 2001, please amend the subject
application as follows:

IN THE CLAIMS:

Cancel claims 29-44 without prejudice to applicants' right to file a division
application with respect thereto.

Please amend claim 52 as follows:

Sub C27
52. (Amended) A method for manufacturing a semiconductor device
comprising steps of:
contacting a material for promoting crystallization to at least a part of an initial
semiconductor film formed over a substrate;
subjecting said semiconductor film to oxygen plasma; and
crystallizing said initial semiconductor film using said material, to obtain a
crystalline semiconductor film.
BX

Please add new claims 60-66 as follows:

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